



# BAV756DW

## QUAD SURFACE MOUNT SWITCHING DIODE ARRAY

#### **Features**

Fast Switching Speed

Ultra-Small Surface Mount Package

For General Purpose Switching Applications

High Conductance

One BAV70 Circuit and One BAW56 Circuit In One Package

Easily Connected As Full Wave Bridge

Lead Free/RoHS Compliant (Note 4)

### Mechanical Data

Case: SOT-363 Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C

Terminals: Solderable per MIL-STD-202, Method 208

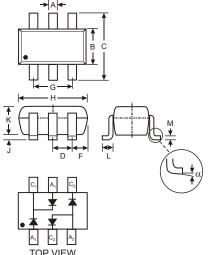
Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).

Polarity: See Diagram

Marking: KCA, See Page 2

Ordering Information: See Page 2

Weight: 0.006 grams (approximate)



SOT-363							
Dim	Min	Max					
Α	0.10	0.30					
В	1.15	1.35					
С	2.00	2.20					
D	0.65 N	ominal					
F	0.30	0.40					
н	1.80	2.20					
J		0.10					
к	0.90	1.00 0.40 0.25					
L	0.25						
м	0.10						
	0	8°					
All Dimensions in mm							

#### **Maximum Ratings** @ T<sub>A</sub> = 25 C unless otherwise specified

Characteristic	Symbol	Value	Unit		
Non-Repetitive Peak Reverse Voltage	V <sub>RM</sub>	100	V		
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	V		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	53	V		
Forward Continuous Current (Note 1 and 3)	I <sub>FM</sub>	300	mA		
Average Rectified Output Current (Note 1 and 3)	Ι <sub>Ο</sub>	150	mA		
Non-Repetitive Peak Forward Surge Current @ $t = 1.0$ s @ $t = 1.0$ s	I <sub>FSM</sub>	2.0 1.0	A		
Power Dissipation (Note 1 and 3)	Pd	200	mW		
Power Dissipation $T_S = 60 C$ (Note 3)	Pd	300	mW		
Thermal Resistance Junction to Ambient Air (Note 1 and 3)	R <sub>JA</sub>	625	C/W		
Thermal Resistance Junction to Soldering Point (Note 3)	R <sub>JS</sub>	275	C/W		
Operating and Storage Temperature Range	Tj, T <sub>STG</sub>	-65 to +150	С		

#### Electrical Characteristics @ T<sub>A</sub> = 25 C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition		
Reverse Breakdown Voltage (Note 2)	V <sub>(BR)R</sub>	75		V	I <sub>R</sub> = 2.5 A		
Forward Voltage	VF		0.715 0.855 1.0 1.25	v	$\begin{array}{l} I_F = 1.0 \text{mA} \\ I_F = 10 \text{mA} \\ I_F = 50 \text{mA} \\ I_F = 150 \text{mA} \end{array}$		
Reverse Current (Note 2)	I <sub>R</sub>		2.5 50 30 25	A A A nA			
Total Capacitance	CT		2.0	pF	V <sub>R</sub> = 0, f = 1.0MHz		
Reverse Recovery Time	t <sub>rr</sub>		4.0	ns	$I_F = I_R = 10mA,$ $I_{rr} = 0.1 \times I_R, R_L = 100$		

Notes: 1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at

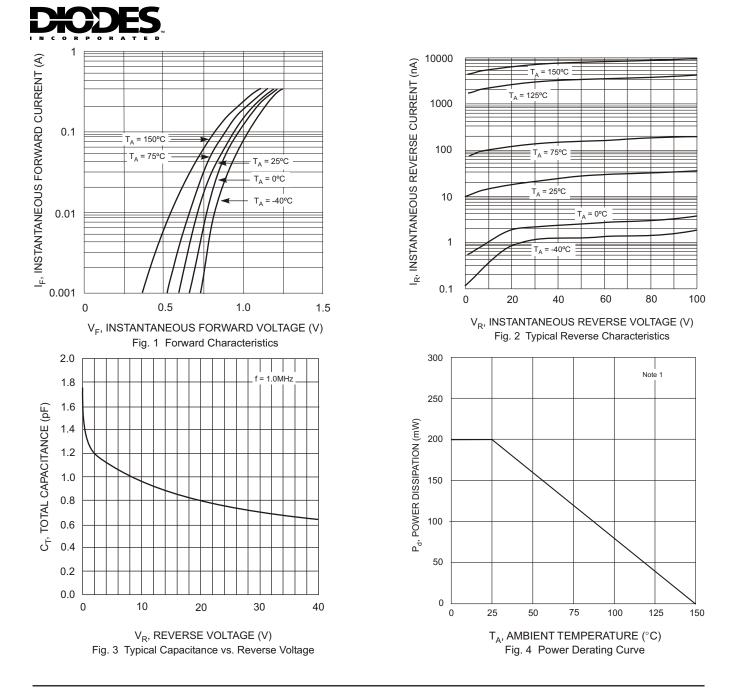
http://www.diodes.com/datasheets/ap02001.pdf.

2. Short duration test pulse used to minimize self-heating effect.

3. One or more diodes loaded.

4. No purposefully added lead.

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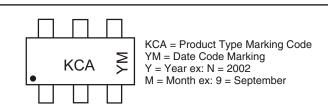


## Ordering Information (Note 5)

Device	Packaging	Shipping		
BAV756DW-7-F	SOT-363	3000/Tape & Reel		

Notes: 5. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**



Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	N	Р	R	S	Т	U	V	W	Х	Y	Z
											1	
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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